

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	321159	induct\$3	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2005/06/07 08:58
S2	272722	S1 not (@rlad>"20020815" @ad>"20020815")	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/06/07 12:44
S3	8116	S2 and (grooves trenches openings recess\$4 ditches furrows) and semiconduct\$3	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	OFF	2005/06/07 09:02
S4	2214	S3 and (grooves trenches openings recess\$4 ditches furrows) same (lower\$3 remov\$3 etch\$3) near7 (bottom distance surface)	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2005/06/07 13:12
S5	2171	S4 and (lower\$3 remov\$3 etch\$3) near7 (top upper surface)	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2005/06/07 09:05
S6	879	S5 and (lower\$3 remov\$3 etch\$3) near7 (top upper surface) near3 (insulat\$3 dielectric oxide dioxide Siox sio2 sio>"sub.2")	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2005/06/07 09:08
S7	879	S6	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2005/06/07 09:08
S8	627	438/638.ccls. not (@rlad>"20020815" @ad>"20020815")	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/06/07 12:44
S9	343	S8 and (grooves trenches openings recess\$4 ditches furrows) same (lower\$3 remov\$3 etch\$3) near7 (bottom distance surface)	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2005/06/07 13:13